SN54ALS541 ... J PACKAGE SN74ALS540 ... DW. N. OR NS PACKAGE

SDAS025D - APRIL 1982 - REVISED MARCH 2002

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- pnp Inputs Reduce dc Loading
- Data Flowthrough Pinout (All Inputs on Opposite Side From Outputs)

description

These octal buffers and line drivers are designed to have the performance of the popular SN54ALS240A/SN74ALS240A series and, at the same time, offer a pinout with inputs and outputs on opposite sides of the package. This arrangement greatly facilitates printed circuit board layout.

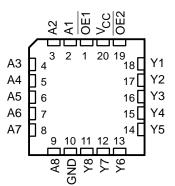
The 3-state control gate is a 2-input NOR gate such that, if either output-enable (OE1 or OE2) input is high, all eight outputs are in the high-impedance state.

The SN74ALS540 provides inverted data. The 'ALS541 provide true data at the outputs.

The -1 versions of SN74ALS540 and SN74ALS541 are identical to the standard versions, except that the recommended maximum I_{OL} is increased to 48 mA. There is no -1 version of the SN54ALS541.

| SN74ALS541 DB, DW, N, OR NS PACKAGE (TOP VIEW) OE1 [1 20] V _{CC} A1 [2 19] OE2 A2 [3 18] Y1 A3 [4 17] Y2 A4 [5 16] Y3 A5 [6 15] Y4 A6 [7 14] Y5 A7 [8 13] Y6 A8 [9 12] Y7 GND [10 11] Y8 | JN/4ALJJ40 | | , 01. 1 | NO LACINAGE |
|--|--------------|---------|---------|-----------------|
| $\begin{array}{c cccc} OE1 & 1 & 20 \\ A1 & 2 & 19 \\ A2 & 3 & 18 \\ A3 & 4 & 17 \\ A3 & 4 & 17 \\ A4 & 5 & 16 \\ A5 & 6 & 15 \\ A6 & 7 & 14 \\ A6 & 7 & 14 \\ A7 & 8 & 13 \\ A8 & 9 & 12 \\ \end{array} \begin{array}{c} V_{CC} \\ V_{CC} \\ OE2 \\ $ | SN74ALS541 [| OB, DW, | N, O | R NS PACKAGE |
| A1 [2 19] OE2 A2 [3 18] Y1 A3 [4 17] Y2 A4 [5 16] Y3 A5 [6 15] Y4 A6 [7 14] Y5 A7 [8 13] Y6 A8 [9 12] Y7 | (| TOP VI | EW) | |
| A1 [2 19] OE2 A2 [3 18] Y1 A3 [4 17] Y2 A4 [5 16] Y3 A5 [6 15] Y4 A6 [7 14] Y5 A7 [8 13] Y6 A8 [9 12] Y7 | | | | |
| A2 [3 18] Y1 A3 [4 17] Y2 A4 [5 16] Y3 A5 [6 15] Y4 A6 [7 14] Y5 A7 [8 13] Y6 A8 [9 12] Y7 | OE1 | 1 | 20 | V _{CC} |
| A3 [4 17] Y2 A4 [5 16] Y3 A5 [6 15] Y4 A6 [7 14] Y5 A7 [8 13] Y6 A8 [9 12] Y7 | A1 [| 2 | 19 | OE2 |
| A4 [5 16] Y3 A5 [6 15] Y4 A6 [7 14] Y5 A7 [8 13] Y6 A8 [9 12] Y7 | A2 [| 3 | 18 | Y1 |
| A5 [6 15] Y4 A6 [7 14] Y5 A7 [8 13] Y6 A8 [9 12] Y7 | A3 [| 4 | 17 | Y2 |
| A6 [7 14] Y5 A7 [8 13] Y6 A8 [9 12] Y7 | A4 [| 5 | 16 | Y3 |
| A7 [] 8 13]] Y6 A8 [] 9 12]] Y7 | A5 [| 6 | 15 | Y4 |
| A8 [] 9 12 [] Y7 | A6 [| 7 | 14 | Y5 |
| | A7 [| 8 | 13 | Y6 |
| GND [10 11 Y8 | A8 [| 9 | 12 | Y7 |
| | GND [| 10 | 11 | Y8 |

SN54ALS541 ... FK PACKAGE (TOP VIEW)





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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 2002, Texas Instruments Incorporated On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

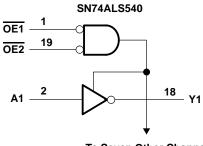
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| Τ _Α | PAC | KAGE [†] | ORDERABLE PART NUMBER | TOP-SIDE MARKING | | | | | | | |
|----------------|-----------|-------------------|--------------------------|---------------------|--|--|--|--|--|--|--|
| | | | SN74ALS540N | SN74ALS540N | | | | | | | |
| | PDIP – N | Tube | SN74ALS540-1N | SN74ALS540-1N | | | | | | | |
| | FDIF - N | Tube | SN74ALS541N | SN74ALS541N | | | | | | | |
| | | | SN74ALS541-1N | SN74ALS541-1N | | | | | | | |
| | | Tube | SN74ALS540DW | ALS540 | | | | | | | |
| | | Tape and reel | SN74ALS540DWR | AL5540 | | | | | | | |
| | | Tube | SN74ALS540-1DW | ALS540-1 | | | | | | | |
| | SOIC – DW | Tube | SN74ALS541DW | ALS541 | | | | | | | |
| 0°C to 70°C | | Tape and reel | SN74ALS541DWR | AL5541 | | | | | | | |
| | | Tube | SN74ALS541-1DW | ALS541-1 | | | | | | | |
| | | Tape and reel | SN74ALS541-1DWR | AL3041-1 | | | | | | | |
| | | Tape and reel | SN74ALS540NSR | ALS540 | | | | | | | |
| | SOP – NS | | SN74ALS540-1NSR | ALS540-1 | | | | | | | |
| | 30F - N3 | Tape and reel | SN74ALS541NSR | ALS541 | | | | | | | |
| | | | SN74ALS541-1NSR | ALS541-1 | | | | | | | |
| | SSOP – DB | Tape and reel | SN74ALS541DBR | G541 | | | | | | | |
| | 330F - DB | Tape and reel | SN74ALS541-1DBR | G541-1 | | | | | | | |
| –55°C to 125°C | CDIP – J | Tube | SNJ54ALS541J | SNJ54ALS541J | | | | | | | |
| -55 C 10 125 C | LCCC – FK | Tube | SNJ54ALS541FK | SNJ54ALS541FK | | | | | | | |

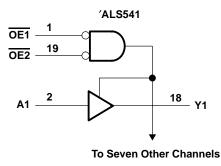
ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

logic diagrams (positive logic)



To Seven Other Channels





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absolute maximum ratings over operating free-air temperature (unless otherwise noted)[†]

| Supply voltage, V _{CC} Input voltage, V _I | | |
|--|--------------|----------------|
| Voltage applied to a disabled 3-state output | | |
| Package thermal impedance, θ_{JA} (see Note 1) | : DB package | 70°C/W |
| | DW package | 58°C/W |
| | N package | 69°C/W |
| | NS package | |
| Storage temperature range, T _{stg} | | –65°C to 150°C |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

| | | SN | 54ALS5 | 41 | _ | 74ALS5 74ALS5 | - | UNIT |
|----------|--------------------------------|-----|--------|-----|-----|------------------|-----|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| VCC | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| V_{IL} | Low-level input voltage | | | 0.7 | | | 0.8 | V |
| ЮН | High-level output current | | | -12 | | | -15 | mA |
| | | | | 12 | | | 24 | mA |
| IOL | Low-level output current | | | | | | 48† | ША |
| ТА | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

 † Applies only to the -1 version and only if V_CC is between 4.75 V and 5.25 V



SDAS025D - APRIL 1982 - REVISED MARCH 2002

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| P | ARAMETER | TEST CO | SN | 54ALS5 | 41 | | 74ALS5 74ALS5 | | UNIT | |
|------------------|------------|-----------------------------------|--------------------------------------|--------------------|------|------|--------------------|------|------|----|
| | | | MIN | түр‡ | MAX | MIN | TYP‡ | MAX | | |
| Vik | | V _{CC} = 4.5 V, | lj = – 18 mA | | | -1.2 | | | -1.2 | V |
| | | V _{CC} = 4.5 V to 5.5 V, | $I_{OH} = -0.4 \text{ mA}$ | V _{CC} –2 | 2 | | V _{CC} -2 | 2 | | |
| V | | | $I_{OH} = -3 \text{ mA}$ | 2.4 | 3.2 | | 2.4 | 3.2 | | V |
| Vон | | V _{CC} = 4.5 V | $I_{OH} = -12 \text{ mA}$ | 2 | | | | | | v |
| | | | I _{OH} = -15 mA | | | | 2 | | | |
| | | | I _{OL} = 12 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | |
| VOL | | V _{CC} = 4.5 V | I _{OL} = 24 mA | | | | | 0.35 | 0.5 | V |
| | | | I _{OL} = 48 mA [†] | | | | | 0.35 | 0.5 | |
| IOZH | | V _{CC} = 5.5 V, | V _O = 2.7 V | | | 20 | | | 20 | μA |
| I _{OZL} | | V _{CC} = 5.5 V, | V _O = 0.4 V | | | -20 | | | -20 | μA |
| Ιį | | V _{CC} = 5.5 V, | V _I = 7 V | | | 0.1 | | | 0.1 | mA |
| IIН | | V _{CC} = 5.5 V, | V _I = 2.7 V | | | 20 | | | 20 | μA |
| ۱ _{۱L} | | V _{CC} = 5.5 V, | V _I = 0.4 V | | | -0.2 | | | -0.1 | mA |
| lO§ | | V _{CC} = 5.5 V, | V _O = 2.25 V | -20 | | -112 | -30 | | -112 | mA |
| | | | Outputs high | | | | | 5 | 10 | |
| | SN74ALS540 | V _{CC} = 5.5 V | Outputs low | | | | | 13 | 22 | |
| 1 | | | Outputs disabled | | | | | 11 | 19 | m۸ |
| lcc | | | Outputs high | | 6 | 14 | | 6 | 14 | mA |
| | | S541 V _{CC} = 5.5 V | Outputs low | | 15 | 25 | | 15 | 25 | |
| | | | Outputs disabled | | 13.5 | 32 | | 13.5 | 22 | |

[†] Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V [‡] All typical values are at V_{CC} = 5 V, T_A = 25°C. § The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

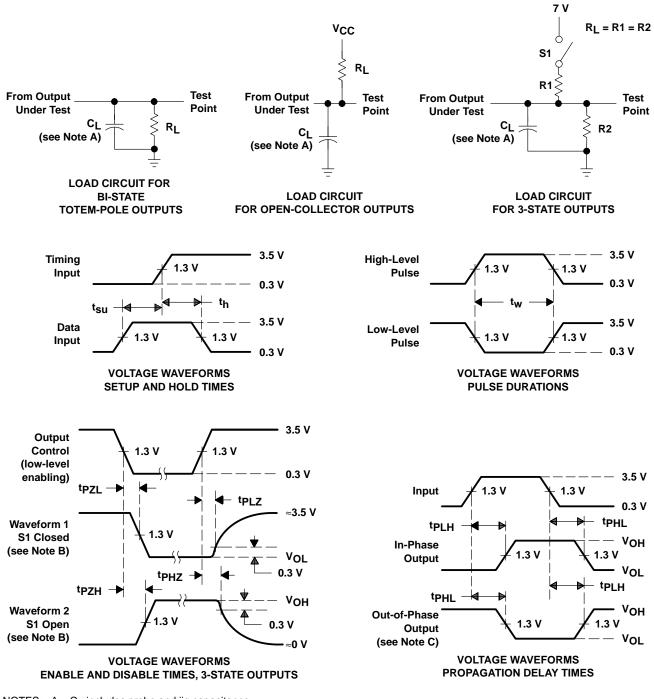
| PARAMETER | FROM (INPUT) | то (оитрит) | | Cl R1 R2 | CC = 4.5 _ = 50 pF l = 500 Ω 2 = 500 Ω A = MIN to | ;, <u>2,</u> <u>2</u> , | | | UNIT | |
|------------------|-----------------|----------------|-------|----------------|---|-------------------------------|-------|-------|------|--|
| | | | SN54A | LS541 | SN74A | LS540 | SN74A | LS541 | | |
| | | | MIN | MAX | MIN | MAX | MIN | MAX | | |
| ^t PLH | А | v | 4 | 17 | 2 | 12 | 4 | 14 | ns | |
| ^t PHL | A | Y | 2 | 14 | 2 | 9 | 2 | 10 | 115 | |
| ^t PZH | OE | V | 5 | 18 | 5 | 15 | 5 | 15 | ns | |
| ^t PZL | ÛE | Y | 8 | 28 | 8 | 20 | 8 | 20 | 115 | |
| ^t PHZ | OE | V | 1 | 12 | 1 | 10 | 1 | 10 | | |
| ^t PLZ | UE | ľ | 2 | 14 | 2 | 12 | 2 | 12 | ns | |

For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_f = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms





PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|--------------------------------|---------|
| 5962-8960201RA | ACTIVE | CDIP | J | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8960201RA SNJ54ALS541J | Samples |
| SN54ALS541J | ACTIVE | CDIP | J | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54ALS541J | Samples |
| SN74ALS540-1N | ACTIVE | PDIP | Ν | 20 | 20 | RoHS & Non-Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74ALS540-1N | Samples |
| SN74ALS540-1NSR | ACTIVE | SO | NS | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS540-1 | Samples |
| SN74ALS540DW | LIFEBUY | SOIC | DW | 20 | 25 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS540 | |
| SN74ALS540DWR | ACTIVE | SOIC | DW | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS540 | Samples |
| SN74ALS540N | ACTIVE | PDIP | N | 20 | 20 | RoHS & Non-Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74ALS540N | Samples |
| SN74ALS540NSR | ACTIVE | SO | NS | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS540 | Samples |
| SN74ALS541-1DW | ACTIVE | SOIC | DW | 20 | 25 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS541-1 | Samples |
| SN74ALS541-1N | ACTIVE | PDIP | N | 20 | 20 | RoHS & Non-Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74ALS541-1N | Samples |
| SN74ALS541-1NE4 | ACTIVE | PDIP | N | 20 | 20 | RoHS & Non-Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74ALS541-1N | Samples |
| SN74ALS541-1NSR | ACTIVE | SO | NS | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS541-1 | Samples |
| SN74ALS541DB | LIFEBUY | SSOP | DB | 20 | 70 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | | G541 | |
| SN74ALS541DBR | ACTIVE | SSOP | DB | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | G541 | Samples |
| SN74ALS541DW | LIFEBUY | SOIC | DW | 20 | 25 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS541 | |
| SN74ALS541DWR | ACTIVE | SOIC | DW | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS541 | Samples |
| SN74ALS541N | ACTIVE | PDIP | N | 20 | 20 | RoHS & Non-Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74ALS541N | Samples |
| SN74ALS541NSR | ACTIVE | SO | NS | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS541 | Samples |
| SN74ALS541NSRE4 | ACTIVE | SO | NS | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS541 | Samples |



8-Sep-2023

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins Pa | ackage Qty | Eco Plan (2) | Lead finish/ Ball material | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|---------|---------------|---------------------|-------------------------------|----------------------|--------------|--------------------------------|---------|
| SNJ54ALS541J | ACTIVE | CDIP | J | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8960201RA SNJ54ALS541J | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54ALS541, SN74ALS541 :



Catalog : SN74ALS541

Military : SN54ALS541

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| SN74ALS540-1NSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.4 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |
| SN74ALS540DWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.3 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74ALS540NSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.4 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |
| SN74ALS541-1NSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.4 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |
| SN74ALS541DBR | SSOP | DB | 20 | 2000 | 330.0 | 16.4 | 8.2 | 7.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74ALS541DWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.3 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74ALS541NSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.4 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |



www.ti.com

PACKAGE MATERIALS INFORMATION

3-Jun-2022



| | 1 | · · · · · · · · · · · · · · · · · · · | | | · | | |
|-----------------|--------------|---------------------------------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| SN74ALS540-1NSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS540DWR | SOIC | DW | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS540NSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS541-1NSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS541DBR | SSOP | DB | 20 | 2000 | 356.0 | 356.0 | 35.0 |
| SN74ALS541DWR | SOIC | DW | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS541NSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |

TEXAS INSTRUMENTS

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3-Jun-2022

TUBE



- B - Alignment groove width

*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ALS540-1N | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| SN74ALS540DW | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| SN74ALS540N | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| SN74ALS541-1DW | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| SN74ALS541-1N | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| SN74ALS541-1NE4 | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| SN74ALS541DW | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| SN74ALS541N | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |

DB0020A



PACKAGE OUTLINE

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-150.



DB0020A

EXAMPLE BOARD LAYOUT

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DB0020A

EXAMPLE STENCIL DESIGN

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



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EXAMPLE BOARD LAYOUT

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



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EXAMPLE STENCIL DESIGN

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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